

32-Channel Vacuum-Fluorescent Display Driver

Features

- ▶ 32 output lines
- ▶ 90V output swing
- ▶ Active pull-down
- ▶ Latches on all outputs
- ▶ Up to 6.0MHz @ $V_{DD} = 5.0V$
- ▶ $-40^{\circ}C$ to $+85^{\circ}C$ operation

Applications

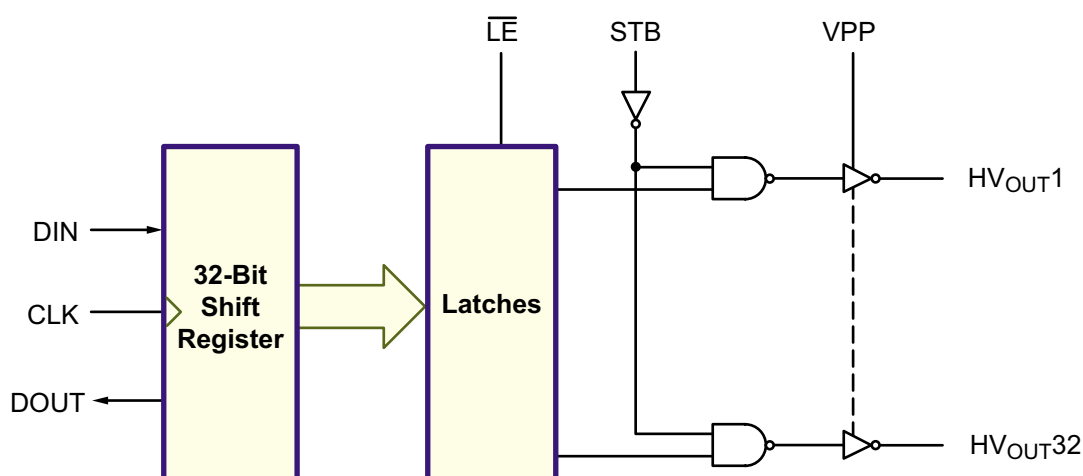
- ▶ Vacuum fluorescent displays
- ▶ DC plasma displays

General Description

The HV518 is designed for vacuum fluorescent or DC plasma applications, where it can serve as a segment, digit or matrix display driver. Each device has 32 outputs, 32 latches and a 32-bit cascadable shift register.

Serial data enters the shift register on the LOW-to-HIGH transition of the clock input. With latch enable (\overline{LE}) HIGH, parallel data is transferred to the output buffers through a 32-bit latch. When \overline{LE} is low the data is stored in the latch. When STROBE is LOW, all outputs are enabled; if STROBE is HIGH, all outputs are LOW.

Block Diagram



Ordering Information

Device	Package Options	
	40-Lead PDIP 1.980x.600in body (max) .250in height (max) .100in pitch	44-Lead PLCC .653x.653in body .180in height (max) .050in pitch
HV518	HV518P-G	HV518PJ-G

-G indicates package is RoHS compliant ("Green")



Absolute Maximum Ratings

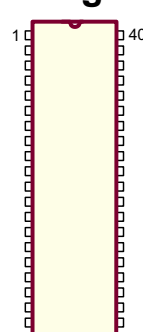
Parameter	Value
Supply voltage, V_{DD}	-0.5V to +6.0V
Supply voltage, V_{PP}	-0.5V to +90V
Logic input levels	-0.5V to $V_{DD} + 0.5V$
Continuous total power dissipation ^{1,2}	1200mW
Operating temperature	-40°C to +85°C
Storage temperature	-65°C to +150°C
Soldering temperature ³	260°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to GND.

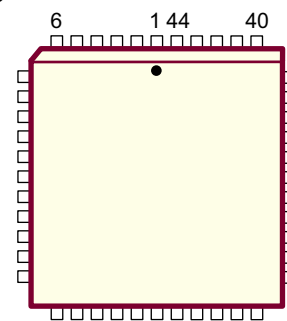
Notes:

- Duty cycle is limited by the total power dissipated in the package.
- For operation above 25°C ambient, derate linearly to 85°C at 20mW/°C.
- Distance of 1.6mm from case for 10 seconds.

Pin Configurations



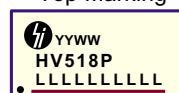
40-Lead PDIP (P)
(top view)



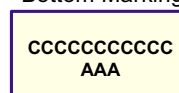
44-Lead PLCC (PJ)
(top view)

Product Markings

Top Marking



Bottom Marking



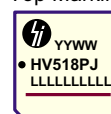
40-Lead PDIP (P)

Y = Last Digit of Year Sealed
WW = Week Sealed
L = Lot Number
C = Country of Origin*
A = Assembler ID*

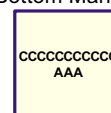
— = "Green" Packaging

*May be part of top marking

Top Marking



Bottom Marking



44-Lead PLCC (PJ)

YY = Year Sealed
WW = Week Sealed
L = Lot Number
C = Country of Origin*
A = Assembler ID*

— = "Green" Packaging

*May be part of top marking

Recommended Operating Conditions ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Sym	Parameter	Min	Max	Unit	Conditions
V_{DD}	Logic supply voltage	4.5	5.5	V	---
V_{PP}	High voltage supply	8.0	80	V	---
V_{IH}	High-level input voltage	3.5	-	V	$V_{DD} = 4.5\text{V}$, See Figure 1
V_{IL}	Low-level input voltage	-	1.0	V	$V_{DD} = 4.5\text{V}$, See Figure 1
I_{OH}	High-level output current	-25	-	mA	---
I_{OL}	Low-level output current	-	2.0	mA	---
f_{CLK}	Clock frequency	-	6.0	MHz	$V_{DD} = 4.5\text{V}$, See Figure 1
$t_{w(CKH)}$	Pulse duration, clock high	83	-	ns	$V_{DD} = 4.5\text{V}$
$t_{w(CKL)}$	Pulse duration, clock low	83	-	ns	$V_{DD} = 4.5\text{V}$
t_{su}	Setup time, data before clock	75	-	ns	$V_{DD} = 4.5\text{V}$
t_h	Hold time, data after clock	75	-	ns	$V_{DD} = 4.5\text{V}$
T_A	Operating ambient temperature	-40	85	$^\circ\text{C}$	---

Electrical Characteristics (over recommended ranges of operating ambient temperature unless otherwise noted.)

Sym	Parameter		Min	Typ	Max	Units	Conditions
I_{DD}	Supply current		-	-	10	mA	$V_{DD} = 5.0\text{V}$, $f_{CH} = 6.0\text{ MHz}$
I_{DDQ}	Quiescent supply current		-	-	0.5	mA	$V_{DD} = 5.5\text{V}$, $V_{IN} = 0\text{V}$
I_{PP}	Supply current		-	-	12	mA	Outputs high, $T_A = -40^\circ$
			-	7.0	10	mA	Outputs high, $T_A = 0\text{ to }+85^\circ$
			-	-	500	μA	Outputs low
V_{OH}	HV_{IN} operating current	HV output	70	-	-	V	$I_{OH} = -25\text{mA}$
		Serial output	4.5	4.9	5.0		$V_{DD} = 5.0\text{V}$, $I_{OH} = -20\mu\text{A}$
V_{OL}	LV_{IN} operating current	HV output	-	-	5.0	V	$I_{OL} = 1.0\text{mA}$
		Serial output	-	0.06	0.8		$I_{OL} = 20\mu\text{A}$
I_{IH}	Logic input current high		-	0.1	1.0	μA	$V_{IH} = V_{DD}$
I_{IL}	Logic input current low		-	-0.1	-1.0	μA	$V_{IL} = 0\text{V}$

Note:

The total number of ON outputs times the duty cycle must not exceed the allowable package power dissipation.

Switching Characteristics ($V_{PP} = 80\text{V}$, $C_L = 50\text{pF}$, $T_A = 25^\circ\text{C}$, unless otherwise noted)

Sym	Parameter		Min	Typ	Max	Unit	Conditions
t_d	Delay time, clock to data output		-	-	600	ns	$C_L = 15\text{pF}$, See Figure 2
t_{DHL}	Delay time, high-to-low-level, HV output	From latch enable	-	-	1.5	μs	$V_{DD} = 4.5\text{V}$, See Figure 3
		From strobe	-	-	1.0		$V_{DD} = 4.5\text{V}$, See Figure 4
t_{DLH}	Delay time, low-to-high-level, HV output	From latch enable	-	-	1.5	μs	$V_{DD} = 4.5\text{V}$, See Figure 3
		From strobe	-	-	1.0		$V_{DD} = 4.5\text{V}$, See Figure 4
t_{THL}	Transition time, high-to-low-level, HV output		-	-	3.0	μs	$V_{DD} = 4.5\text{V}$, See Figure 4
t_{TLH}	Transition time, low-to-high-level, HV output		-	-	2.5	μs	$V_{DD} = 4.5\text{V}$, See Figure 4

Power-Up/ Power-Down Sequences

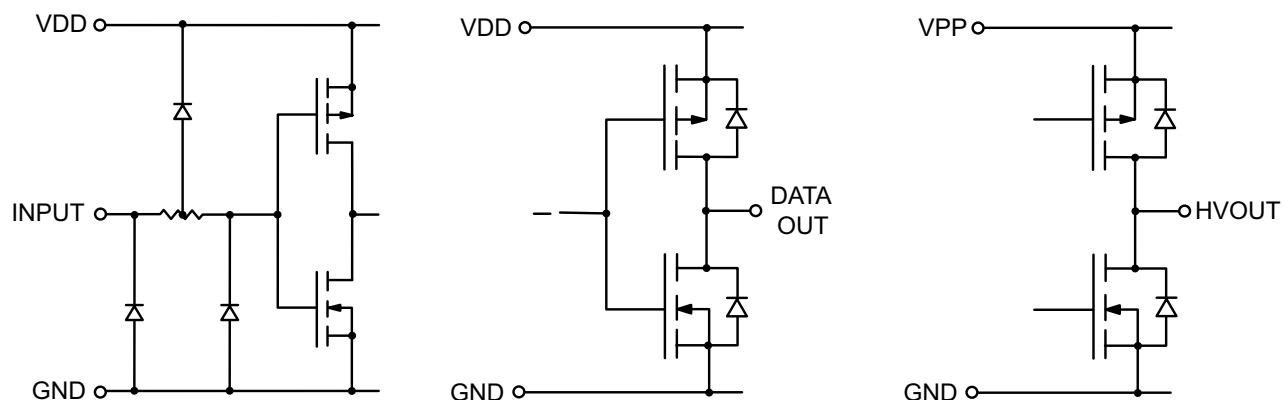
Power-up sequence should be the following:

1. Connect ground.
2. Apply V_{DD} .
3. Set all inputs (Data, CLK, Enable, etc.) to a known state.
4. Apply V_{PP} .

The V_{PP} should not drop below V_{DD} or float during operation.

Power-down sequence should be the reverse of the above.

Input and Output Equivalent Circuits



Parameter Measurement Information

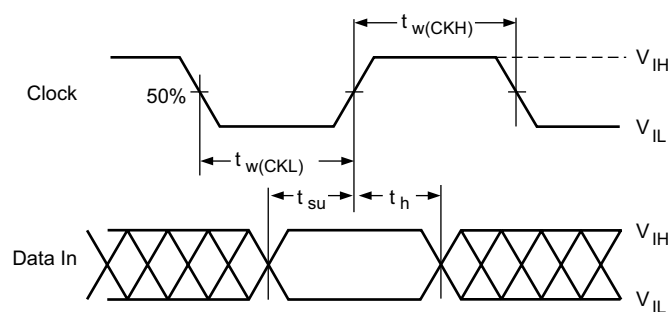


Figure 1: Input Timing Voltage Waveforms

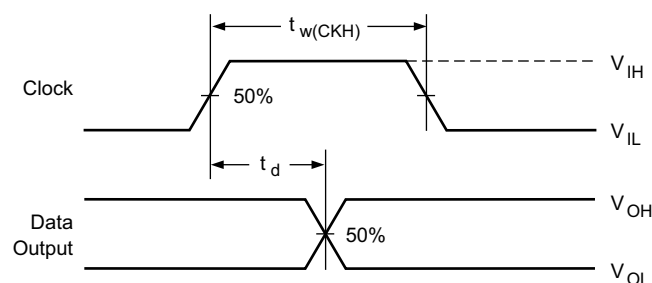


Figure 2

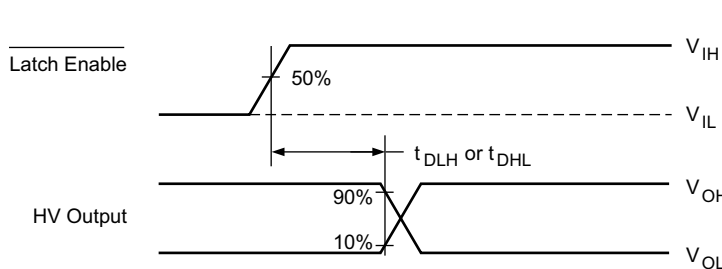


Figure 3

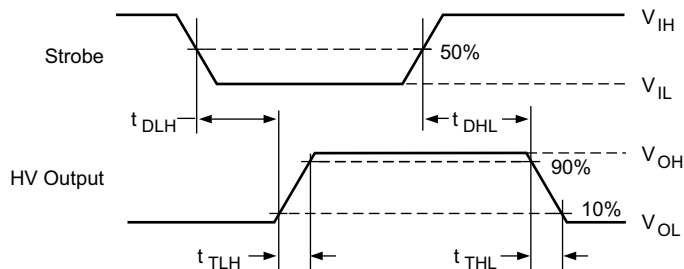




Figure 4: Switching-Time Voltage Waveforms

Note:

For testing purposes, all input pulses have maximum rise and fall times of 30 nsec.

Truth Tables

Input

Data In	CLK	Data Out
H		H
L		L
X	No Change	*

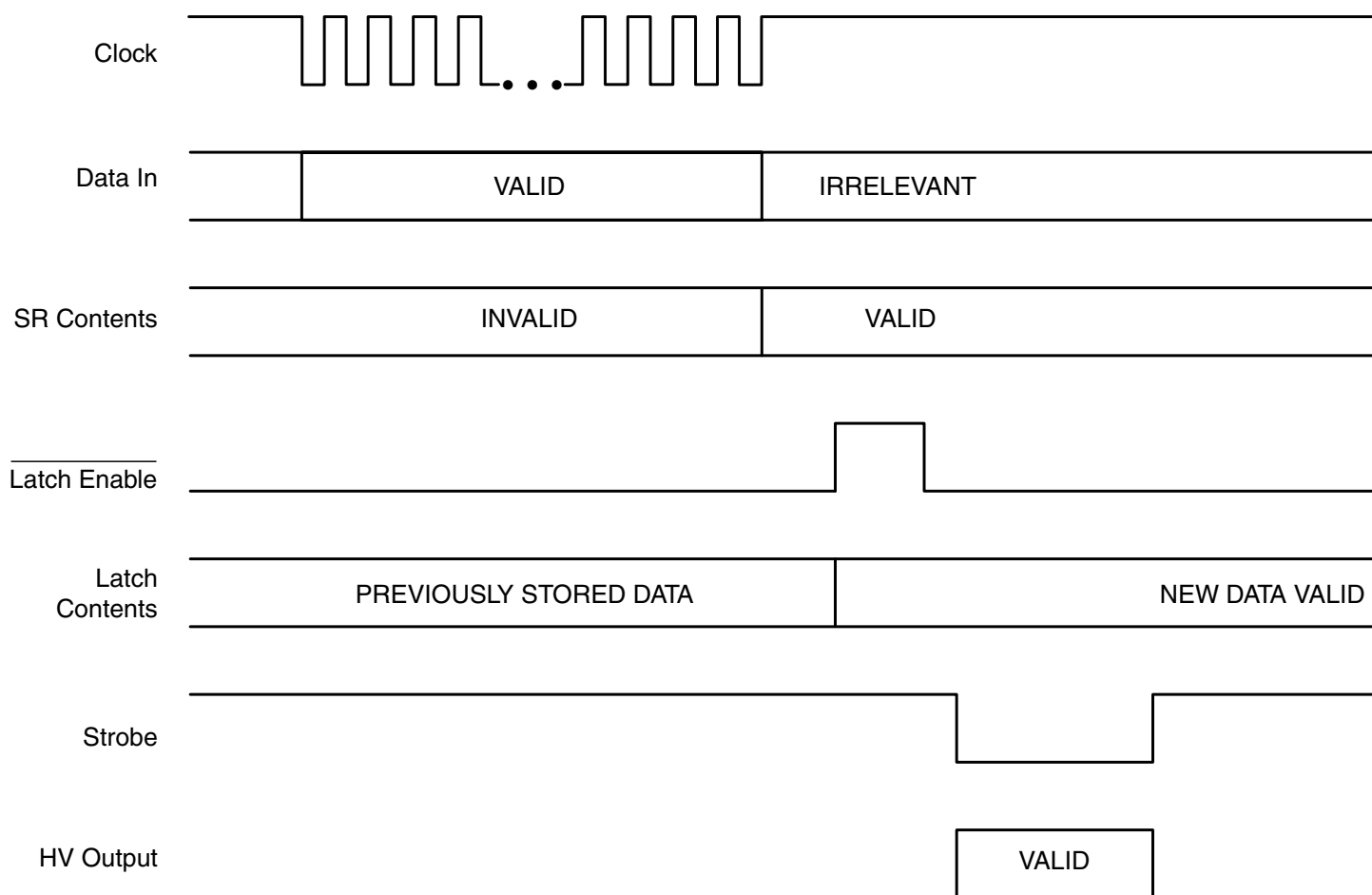
* Previous state.

Output

Data In	\overline{LE}	STB	HV Outputs
X	X	H	All Low
H	H	L	High
L	H	L	Low
X	L	L	*

* Previous state.

Typical Operating Sequence



Pin Descriptions

40-Lead PDIP (P)

Pin #	Function
1	VPP
2	SERIAL OUT
3	HV _{OUT} 32
4	HV _{OUT} 31
5	HV _{OUT} 30
6	HV _{OUT} 29
7	HV _{OUT} 28
8	HV _{OUT} 27
9	HV _{OUT} 26
10	HV _{OUT} 25
11	HV _{OUT} 24
12	HV _{OUT} 23
13	HV _{OUT} 22
14	HV _{OUT} 21

Pin #	Function
15	HV _{OUT} 20
16	HV _{OUT} 19
17	HV _{OUT} 18
18	HV _{OUT} 17
19	STROBE
20	GND
21	CLOCK
22	$\overline{\text{LE}}$
23	HV _{OUT} 16
24	HV _{OUT} 15
25	HV _{OUT} 14
26	HV _{OUT} 13
27	HV _{OUT} 12
28	HV _{OUT} 11

Pin #	Function
29	HV _{OUT} 10
30	HV _{OUT} 9
31	HV _{OUT} 8
32	HV _{OUT} 7
33	HV _{OUT} 6
34	HV _{OUT} 5
35	HV _{OUT} 4
36	HV _{OUT} 3
37	HV _{OUT} 2
38	HV _{OUT} 1
39	DATA IN
40	VDD

44-Lead PLCC (PJ)

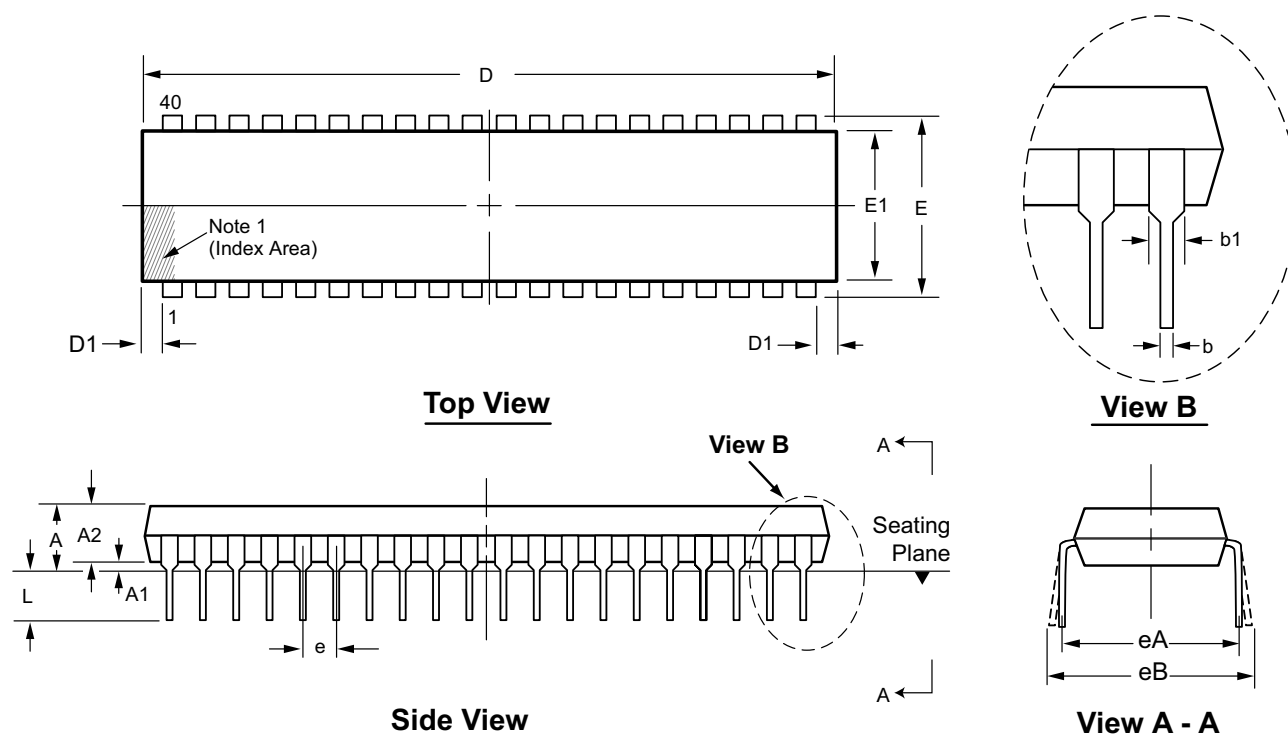
Pin #	Function
1	VPP
2	SERIAL OUT
3	HV _{OUT} 32
4	HV _{OUT} 31
5	HV _{OUT} 30
6	NC
7	HV _{OUT} 29
8	HV _{OUT} 28
9	HV _{OUT} 27
10	HV _{OUT} 26
11	HV _{OUT} 25
12	HV _{OUT} 24
13	HV _{OUT} 23
14	HV _{OUT} 22
15	HV _{OUT} 21

Pin #	Function
16	HV _{OUT} 20
17	HV _{OUT} 19
18	N/C
19	HV _{OUT} 18
20	HV _{OUT} 17
21	STROBE
22	GND
23	CLOCK
24	$\overline{\text{LE}}$
25	HV _{OUT} 16
26	HV _{OUT} 15
27	HV _{OUT} 14
28	N/C
29	N/C
30	HV _{OUT} 13

Pin #	Function
31	HV _{OUT} 12
32	HV _{OUT} 11
33	HV _{OUT} 10
34	HV _{OUT} 9
35	HV _{OUT} 8
36	HV _{OUT} 7
37	HV _{OUT} 6
38	HV _{OUT} 5
39	HV _{OUT} 4
40	HV _{OUT} 3
41	HV _{OUT} 2
42	HV _{OUT} 1
43	DATA IN
44	VDD

40-Lead PDIP (.600in Row Spacing) Package Outline (P)

2.095x.580in body (max), .250in height (max), .100in pitch



- Note:**
1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 Identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbol		A	A1	A2	b	b1	D	D1	E	E1	e	eA	eB	L
Dimension (inches)	MIN	.140*	.015	.125	.014	.030	1.980	.065 [†]	.590 [†]	.485	.100 BSC	.600 BSC	.600*	.115
	NOM	-	-	-	-	-	-	-	-	-			-	-
	MAX	.250	.055*	.195	.023 [†]	.070	2.095	.085*	.625	.580			.700	.200

JEDEC Registration MS-011, Variation AC, Issue B, June, 1988.

* This dimension is not specified in the original JEDEC drawing. The value listed is for reference only.

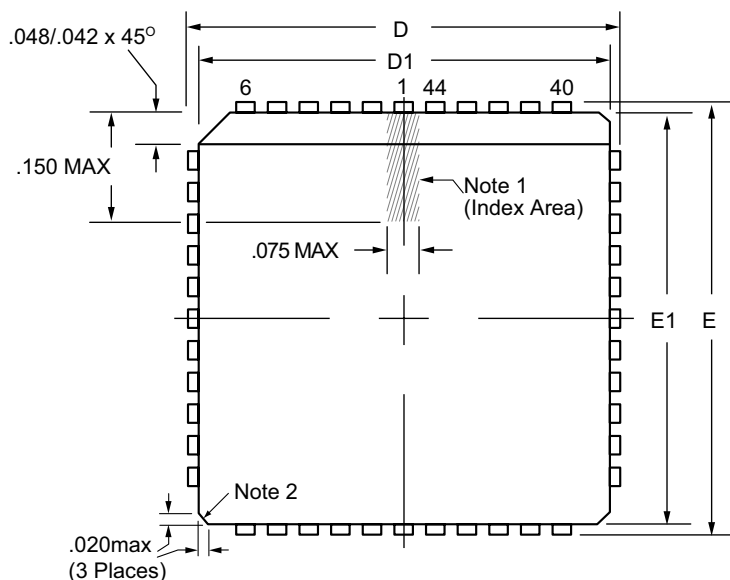
† This dimension is a non-JEDEC dimension.

Drawings not to scale.

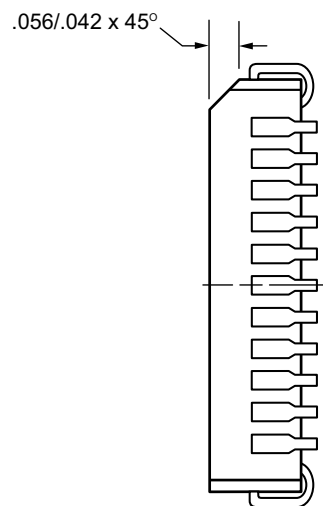
Supertex Doc. #: DSPD-40DIPP, Version B090608.

44-Lead PLCC Package Outline (PJ)

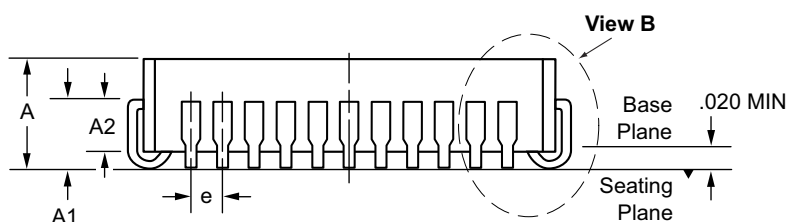
.653x.653in body, .180in height (max), .050in pitch



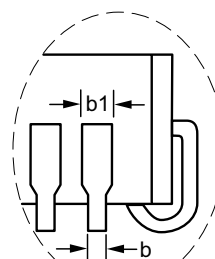
Top View



Vertical Side View



Horizontal Side View



View B

Notes:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.
2. Actual shape of this feature may vary.

Symbol		A	A1	A2	b	b1	D	D1	E	E1	e
Dimension (inches)	MIN	.165	.090	.062	.013	.026	.685	.650	.685	.650	.050 BSC
	NOM	.172	.105	-	-	-	.690	.653	.690	.653	
	MAX	.180	.120	.083	.021	.036†	.695	.656	.695	.656	

JEDEC Registration MS-018, Variation AC, Issue A, June, 1993.

† This dimension is a non-JEDEC dimension.

Drawings not to scale.

Supertex Doc. #: DSPD-44PLCCPJ, Version D092408.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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